Express Mail No. ER885314503US Attorney Docket No.: AM-2044.C2

THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Tony Chiang et al.

SERIAL NO.: 10/796,602

FILED: March 8, 2004

§ EXAMINER: J. Mercado (Parent Application)

§ GROUP ART UNIT: 1745 (Parent Application)

FOR: METHOD OF PREVENTING DIFFUSION

OF COPPER THROUGH A

TANTALUM-COMPRISING BARRIER LAYER

§ Attorney Docket No.:

AM-2044.C2

Date: July 8, 2004

# INFORMATION DISCLOSURE STATEMENT **UNDER 37 CFR § 1.97(b)(3)**

Hon. Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

In accordance with 37 CFR § 1.97(b)(3), applicants hereby request consideration of this Information Disclosure Statement. This Information Disclosure Statement is being submitted prior to the receipt of a first Office Action in the subject application. Applicants are providing herewith a copy of each document cited on the attached Form PTO-1449.

### **CERTIFICATE OF MAILING UNDER 37 CFR 1.10**

I hereby certify that this paper is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as U.S. EXPRESS MAIL NO. ER885314503US in an envelope addressed to: Mail Stop DD, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date: July 7, 2004

Shirley L. Church, Reg. No. 31,858

The submission of this Information Disclosure Statement and Form PTO-1449 is not an admission that the art cited is "prior art" with respect to the present invention, nor is it a representation that no better art exists. Applicants hereby reserve the right to swear behind or otherwise disprove any alleged "prior" nature of any art cited should the facts support and the situation warrant such an action.

If the Examiner has any questions, he is respectfully requested to contact the undersigned attorney at the telephone number set forth below.

Respectfully submitted,

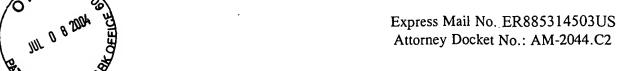
Shirley L Church

Registration No. 31,858 Attorney for Applicants

Church

(650) 473-9700

Correspondence Address:
Patent Counsel
Applied Materials, Inc.
P.O. Box 450-A
Santa Clara, California 95052



ED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Tony Chiang et al.

(Parent Application)

SERIAL NO.: 10/796,602

FILED: March 8, 2004

EXAMINER: J. Mercado

§ GROUP ART UNIT: 1745

(Parent Application)

FOR: METHOD OF PREVENTING DIFFUSION OF COPPER

THROUGH A TANTALUM-COMPRISING BARRIER

§ Attorney Docket No.:

LAYER

AM-2044.C2

Date: July 8, 2004

## INFORMATION DISCLOSURE STATEMENT TRANSMITTAL LETTER

Hon. Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Applicants are submitting the subject Information Disclosure Statement under 37 CFR § 1.97(b)(3). This Information Disclosure Statement is being submitted prior to the receipt of a first Office Action in the subject application.

## **CERTIFICATE OF MAILING UNDER 37 CFR 1.10**

I hereby certify that this paper is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as U.S. EXPRESS MAIL NO. ER885314503US in an envelope addressed to: Mail Stop DD, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

Date: July 8, 2004

Shirley I//Church, Reg. No. 31,858

Applicants do not believe that any fee is due in connection with the filing of this Information Disclosure Statement under 37 CFR § 1.97(b)(3). However, in the event that any additional fee is due, the Commissioner is hereby authorized to charge Deposit Account No. 50-1512 of Shirley L. Church, Sunnyvale, California, in the amount of such fee.

This transmittal letter is submitted in duplicate for accounting purposes.

Respectfully submitted,

Shirley L. Church

Registration No. 31,858

·Church

Attorney for Applicants

Correspondence Address:
Patent Counsel
Applied Materials, Inc.
P.O. Box 450-A
Santa Clara, California 95052

FORM PTO-1449 (Equivalent)

U.S. Department of Commerce Patent and Trademark Office

U.S. Application Serial No. 10/796,602

Atty. Docket No. AM-2044.C2



# INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use several sheets if necessary)

Tony Chiang et al. Applicants

March 8, 2004 Filing Date

<u>1745</u> Group

#### **U. S. PATENT DOCUMENTS**

| Examiner<br><u>Initial</u> | Document<br>Number | Issue<br>Date | Name           | Class | Subclass | Filing Date If Appropriate |
|----------------------------|--------------------|---------------|----------------|-------|----------|----------------------------|
|                            | 4,407,712          | 10/04/83      | Henshaw et al. | 204   | 298      |                            |
|                            | 4,514,437          | 04/30/85      | Nath           | 427   | 39       |                            |
|                            | 4,657,778*         | 04/14/87      | Moran          | 427   | 53.1     |                            |
|                            | 4,792,842**        | 12/20/88      | Honma et al.   | 357   | 71       |                            |
|                            | 4,944,961          | 07/31/90      | Lu et al.      | 427   | 38       |                            |
|                            | 4,976,839          | 12/11/90      | Inoue          | 204   | 192.17   |                            |
|                            | 5,186,718          | 02/16/93      | Tepman et al.  | 29    | 25.01    |                            |
|                            | 5,236,868          | 08/17/93      | Nulman         | 437   | 190      |                            |
|                            | 5,246,885          | 09/21/93      | Braren et al.  | 437   | 225      |                            |
|                            | 5,281,854**        | 01/25/94      | Wong           | 257   | 740      |                            |
|                            | 5,302,266**        | 04/12/94      | Grabarz et al. | 204   | 192.12   |                            |
|                            |                    |               |                |       |          |                            |

Examiner Date Considered

Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

- \* Cited by the Examiner in parent application, U.S. Serial No. 09/886,439, and/or grandparent application, U.S. Serial No. 08/978,792.
- \*\* Cited on Search Report in corresponding PCT Application No. PCT/US98/22796.

| TT | 2 | DA | TEN | מ ד  | റ            | תדי | <b>MENT</b> | S |
|----|---|----|-----|------|--------------|-----|-------------|---|
|    |   |    |     | 1 17 | $\mathbf{v}$ |     |             |   |

| Examiner<br>Initial | Document<br>Number | Issue<br><u>Date</u> | Name          | Class | Subclass | Filing Date If Appropriate |
|---------------------|--------------------|----------------------|---------------|-------|----------|----------------------------|
|                     | 5,312,509          | 05/17/94             | Eschbach      | 156   | 345      |                            |
|                     | 5,320,728          | 06/14/94             | Tepman        | 204   | 192.12   |                            |
|                     | 5,354,712          | 10/11/94             | Ho et al.     | 437   | 195      |                            |
|                     | 5,358,616          | 10/25/94             | Ward          | 204   | 192.15   |                            |
|                     | 5,478,455          | 12/26/95             | Actor et al.  | 204   | 192.13   |                            |
|                     | 5,520,784          | 05/28/96             | Ward          | 204   | 192.15   |                            |
|                     | 5,585,673          | 12/17/96             | Joshi et al.  | 257   | 751      |                            |
|                     | 5,589,713**        | 12/31/96             | Lee et al.    | 257   | 773      |                            |
|                     | 5,658,438*         | 08/19/97             | Givens et al. | 204   | 192.11   |                            |
|                     | 5,723,367**        | 03/03/98             | Wada et al.   | 437   | 248      | 02/20/96                   |
|                     | 5,725,739*         | 03/10/98             | Hu            | 204   | 192.3    | 07/08/96                   |
|                     | 5,780,357          | 07/14/98             | Xu et al.     | 438   | 639      | 06/02/97                   |
|                     | 5,783,282*         | 07/21/98             | Leiphart      | 428   | 138      | 10/07/96                   |
|                     | 5,897,752*         | 04/27/99             | Hong et al.   | 204   | 192.12   | 05/20/97                   |
|                     | 5,962,923          | 10/05/99             | Xu et al.     | 257   | 774      | 08/07/95                   |
|                     | 6,605,197          | 08/12/03             | dING ET AL.   | 204   | 192.15   | 05/13/97                   |
|                     |                    |                      |               |       |          |                            |

| Examiner | Date Considered |
|----------|-----------------|

Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>\*</sup> Cited by the Examiner in parent application, U.S. Serial No. 09/886,439, and/or grandparent application, U.S. Serial No. 08/978,792.

<sup>\*\*</sup> Cited on Search Report in corresponding PCT Application No. PCT/US98/22796.

## FOREIGN PATENT DOCUMENTS

| Examiner<br>Initial | Document<br>Number  | Publication<br><u>Date</u> | Name                           | Class        | Subclass         | Translation If Appropriate |  |  |
|---------------------|---|----------------------------|--------------------------------|--------------|------------------|----------------------------|--|--|
|                     | EP 0451571**  | 10/16/91                   | Wang                           | H01L         | 21/3205          |                            |  |  |
|                     | EP 0823279  | 11/02/98                   | Aitchison                      | B01D         | 53/46            |                            |  |  |
|                     | JP 8097279**  | 12/04/96                   | Shima et al.                   | H01L         | 021/768          |                            |  |  |
| ·                   | OTHER   | DOCUMEN                    | TS (Including Author, Title, D | eate, Pertin | nent Pages, etc. | )                          |  |  |
|                     | Rossnagel et al., "Metal ion deposition from ionized mangetron sputtering discharge", J. Vac. Sci. Technol. B, Vol. 12, No. 1, pp. 449 - 453 (Jan/Feb 1994).  |                            |                                |              |                  |                            |  |  |
|                     | Rossnagel et al., "Thin, high atomic weight refractory film deposition for diffusion barrier, adhesion layer, and seed layer applications", <i>J. Vac. Sci. Technol.</i> B, Vol. 14, No. 3, pp.1819 - 1827 (May/Jun 1996) |                            |                                |              |                  |                            |  |  |

Examiner

Date Considered

Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

- \* Cited by the Examiner in parent application, U.S. Serial No. 09/886,439, and/or grandparent application, U.S. Serial No. 08/978,792.
- \*\* Cited on Search Report in corresponding PCT Application No. PCT/US98/22796.